

A

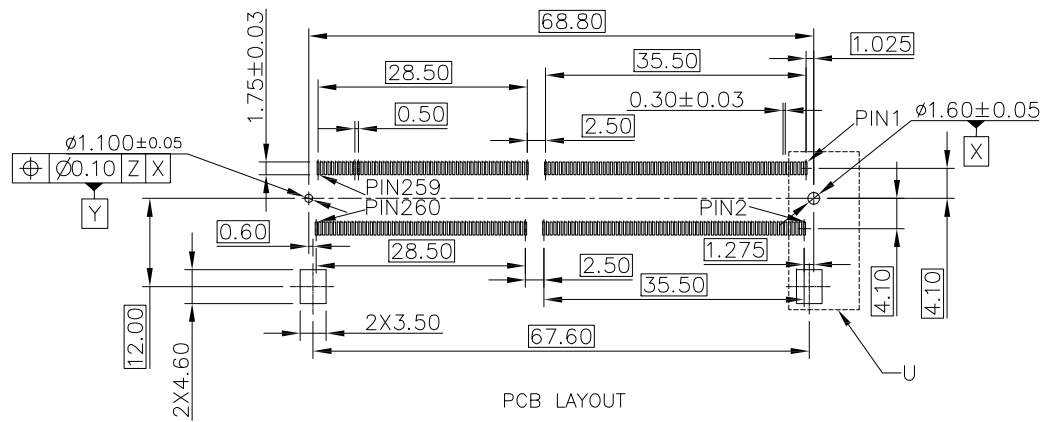
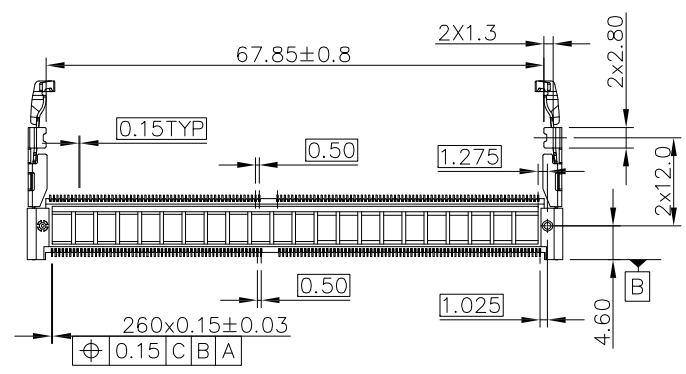
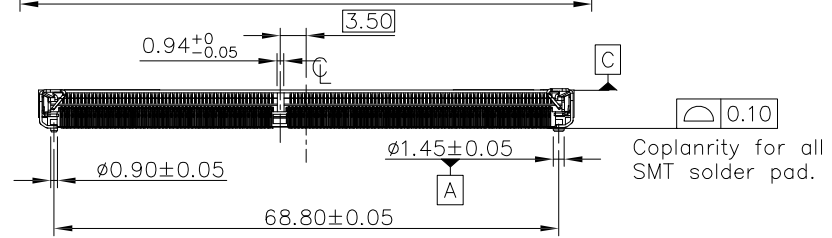
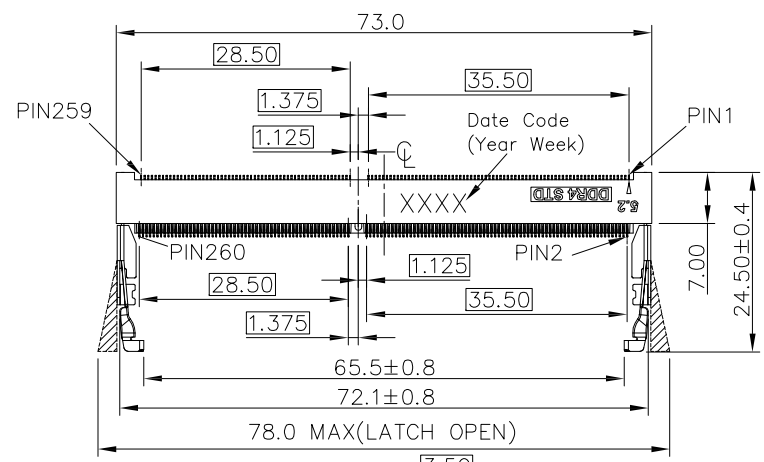
B

C

D

E


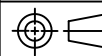
F



NOTES:

- MATERIAL:  
HOUSING :LCP;COLOR:BLACK,UL94 V-0  
TERMINAL: PHOSPHOR BRONZE  
LATCH:STAINLESS STEEL
- FINISH:  
TERMINAL:  
NICKEL UNDERPLATING ALL OVER BASE MATERIAL  
CONTACT AREA : GOLD PLATING OVER UNDERPLATE  
THICKNESS REFER TO PART NO. DESCRIPTION  
SOLDER AREA : GOLD FLASH PLATING OVER UNDERPLATE  
LATCH:MATTF TIN PLATING OVFR NICKEL.
- PART NO. DESCRIPTION: **8511781-A1B□52A**

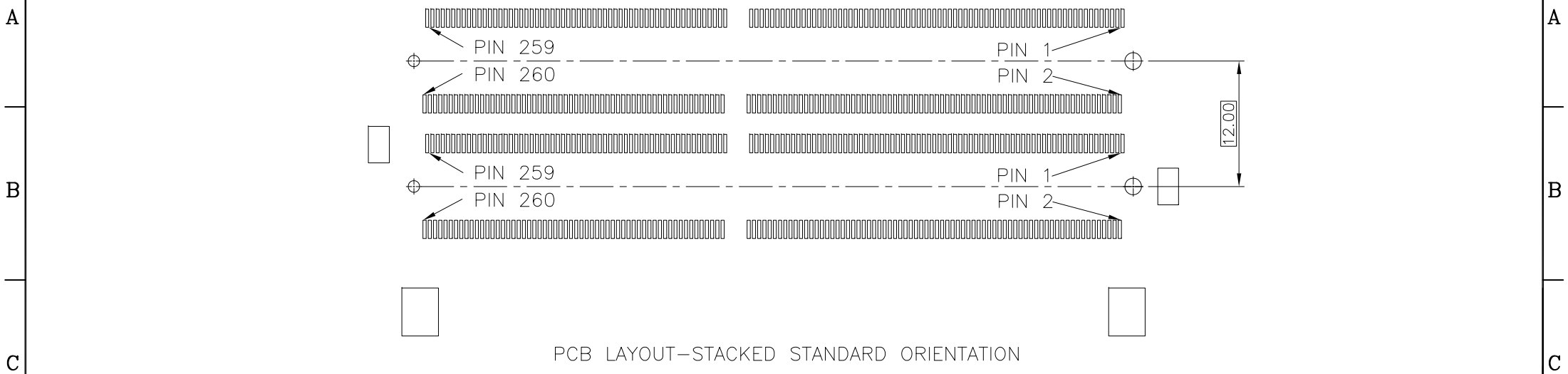
- CONTACT AREA PLATING
- F=GOLD FLASH
  - B=5u"GOLD
  - C=10u"GOLD
  - D=15u"GOLD
  - E=30u"GOLD
  - G=90u"NICKEL ,15u"GOLD

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.X ± 0.30	APPROVED: Chris	 <a href="http://www.rego.com.tw">http://www.rego.com.tw</a>
.XX ± 0.20	CHECKED: Denny	
.XXX± 0.15	DRAWN: Vicky	
X* ± 3'		
 UNITS: mm	SCALE: NONE	TITLE: DDR4 STANDARD H5.2 PART NO: 8511781-A1BF52A SHEET: 1 OF 1

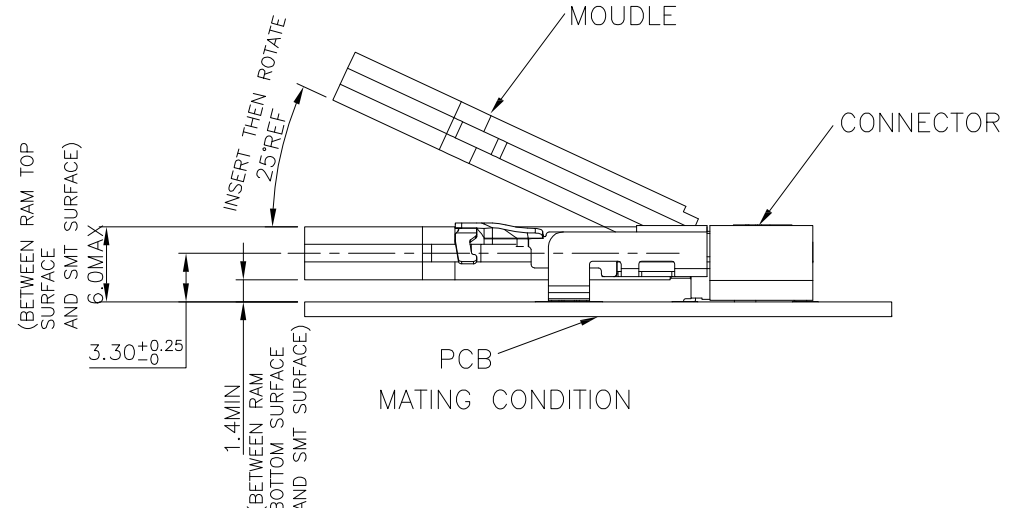
B	03.09.2016
REV	DATE



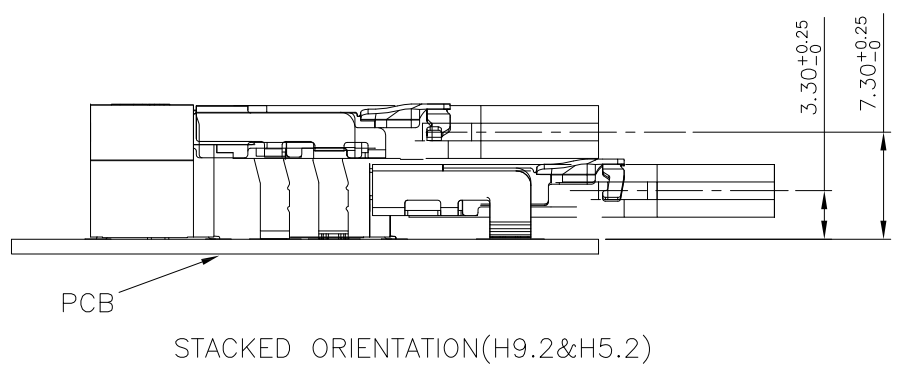
1 2 3 4 5 6 7 8 9 10




PCB LAYOUT—STACKED STANDARD ORIENTATION



MATING CONDITION



STACKED ORIENTATION(H9.2&H5.2)

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.XX ± 0.20	CHECKED: Denny		
.XXX ± 0.15	DRAWN: Vicky		
X* ± 3'	UNITS: mm	SCALE: NONE	TITLE: DDR4 STANDARD H5.2 PART NO: 8511781-A1BF52A SHEET: 1 OF 1

B	03.09.2016
REV	DATE

1 2 3 4 5 6 7 8 9 10